



**Alfa-MOS  
Technology**

**AFN2442W  
40V N-Channel  
Enhancement Mode MOSFET**

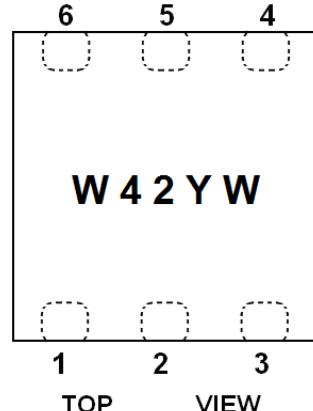
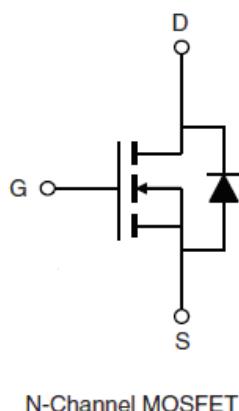
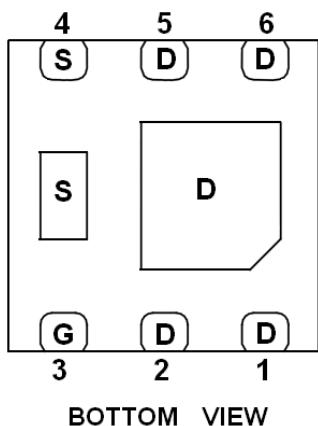
## General Description

AFN2442W, N-Channel enhancement mode MOSFET, uses Advanced Trench Technology to provide excellent  $R_{DS(ON)}$ , low gate charge. These devices are particularly suited for low voltage power management, and low in-line power loss are needed in commercial industrial surface mount applications.

## Features

- $I_D=8A, R_{DS(ON)}= 24m\Omega @ V_{GS}=10V$
- $I_D=6A, R_{DS(ON)}= 34m\Omega @ V_{GS}=4.5V$
- Super high density cell design for extremely low  $R_{DS(ON)}$
- DFN2X2-6L package design

## Pin Description ( DFN2X2-6L )



## Application

- DC/DC Converter
- High Frequency Switching

## Pin Define

Pin	Symbol	Description
1,2,5,6	D	Drain
4	S	Source
3	G	Gate

## Ordering Information

Part Ordering No.	Part Marking	Package	Unit	Quantity
AFN2442WFN226RG	W42YW	DFN2X2-6L	Tape & Reel	4000 EA

※ W42 part code

※ Y year code

※ W week code

※ AFN2442WFN226RG : 7" Tape & Reel ; Pb- Free ; Halogen- Free



**Alfa-MOS  
Technology**

**AFN2442W  
40V N-Channel  
Enhancement Mode MOSFET**

### Absolute Maximum Ratings

( $T_A=25^\circ\text{C}$  Unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	$V_{DSS}$	40	V
Gate –Source Voltage	$V_{GSS}$	$\pm 20$	V
Continuous Drain Current( $T_J=150^\circ\text{C}$ )	$I_D$	8	A
		6	
Pulsed Drain Current	$I_{DM}$	20	A
Continuous Source Current(Diode Conduction)	$I_S$	8	A
Power Dissipation	$P_D$	2	W
		1.5	
Operating Junction Temperature	$T_J$	150	$^\circ\text{C}$
Storage Temperature Range	$T_{STG}$	-55/150	$^\circ\text{C}$
Thermal Resistance-Junction to Ambient	$R_{\theta JA}$	56	$^\circ\text{C}/\text{W}$

### Electrical Characteristics

( $T_A=25^\circ\text{C}$  Unless otherwise noted)

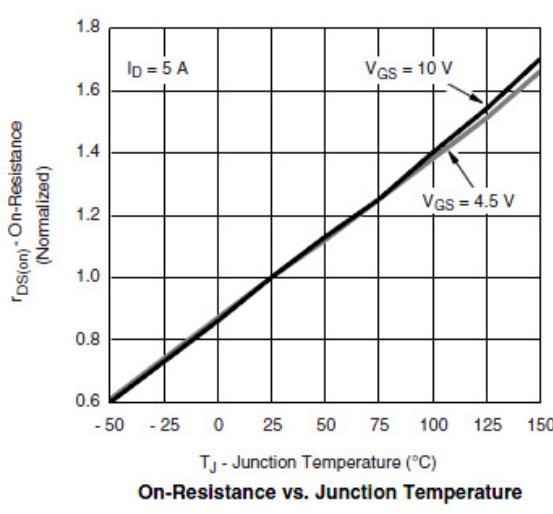
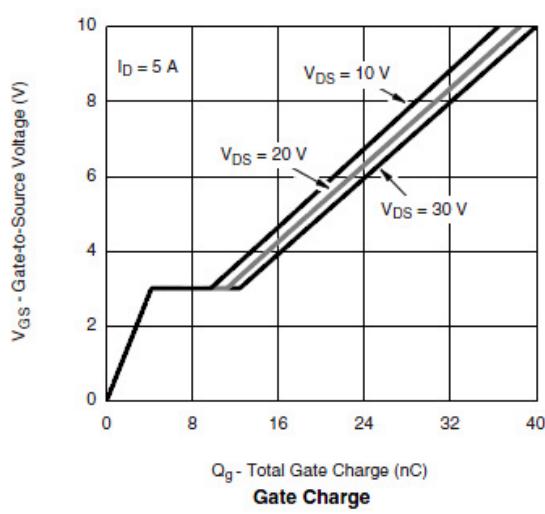
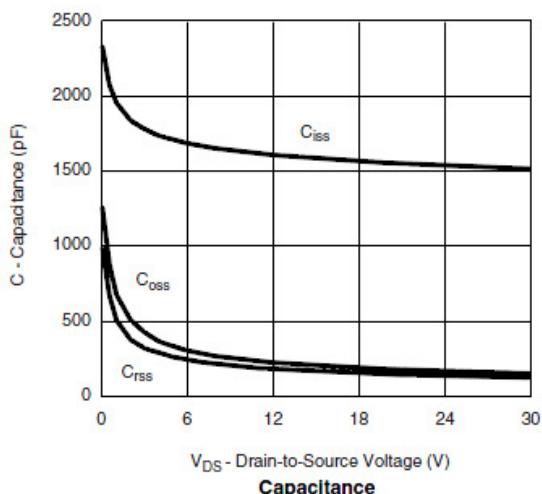
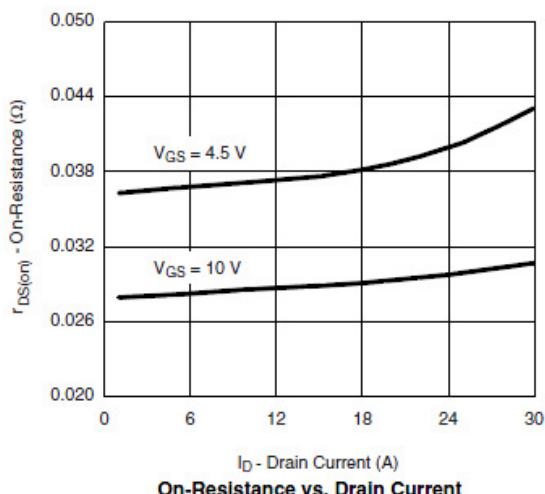
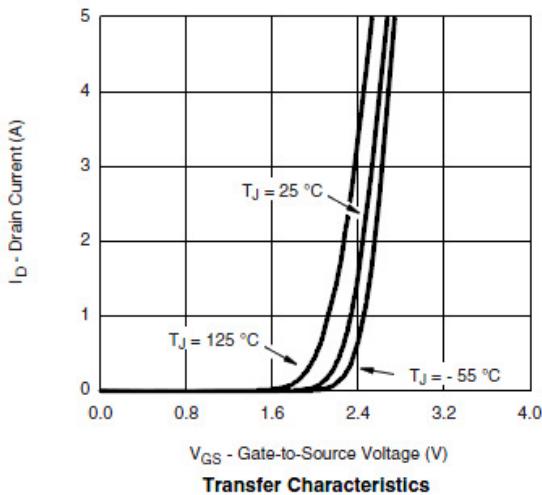
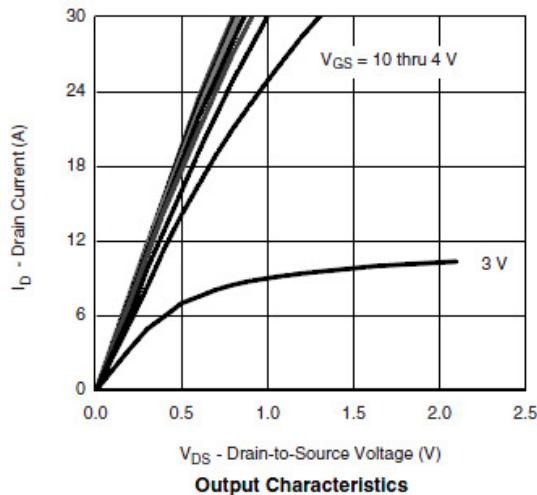
Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
<b>Static</b>						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS}=0\text{V}, I_D=250\mu\text{A}$	40			V
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$	1.0		3.0	
Gate Leakage Current	$I_{GSS}$	$V_{DS}=0\text{V}, V_{GS}=\pm 16\text{V}$			$\pm 100$	nA
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS}=32\text{V}, V_{GS}=0\text{V}$			1	uA
		$V_{DS}=32\text{V}, V_{GS}=0\text{V}$ $T_J=85^\circ\text{C}$			10	
On-State Drain Current	$I_{D(\text{on})}$	$V_{DS} \geq 5\text{V}, V_{GS}=10\text{V}$	15			A
Drain-Source On-Resistance	$R_{D(\text{on})}$	$V_{GS}=10\text{V}, I_D=8\text{A}$		18	24	$\text{m}\Omega$
		$V_{GS}=4.5\text{V}, I_D=6\text{A}$		25	34	
Forward Transconductance	$g_{FS}$	$V_{DS}=15\text{V}, I_D=5.0\text{A}$		25		S
Diode Forward Voltage	$V_{SD}$	$I_S=2\text{A}, V_{GS}=0\text{V}$		0.85	1.2	V
<b>Dynamic</b>						
Total Gate Charge	$Q_g$	$V_{DS}=20\text{V}, V_{GS}=4.5\text{V}$ $I_D=5\text{A}$		10	14	nC
Gate-Source Charge	$Q_{gs}$			2.8		
Gate-Drain Charge	$Q_{gd}$			3.2		
Input Capacitance	$C_{iss}$	$V_{DS}=20\text{V}, V_{GS}=0\text{V}$ $f=1\text{MHz}$		850		pF
Output Capacitance	$C_{oss}$			110		
Reverse Transfer Capacitance	$C_{rss}$			75		
Turn-On Time	$t_{d(\text{on})}$	$V_{DD}=20\text{V}, R_L=4\Omega$ $I_D=5.0\text{A}, V_{GEN}=10\text{V}$		6	12	ns
	$t_r$			10	20	
Turn-Off Time	$t_{d(\text{off})}$			20	36	
	$t_f$			6	12	



**Alfa-MOS  
Technology**

**AFN2442W  
40V N-Channel  
Enhancement Mode MOSFET**

### Typical Characteristics ( P-Channel )

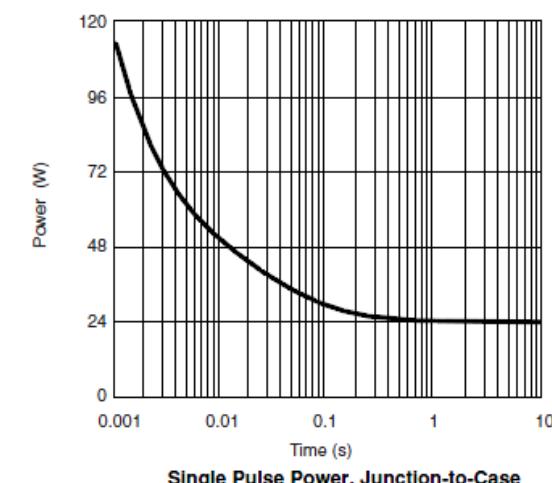
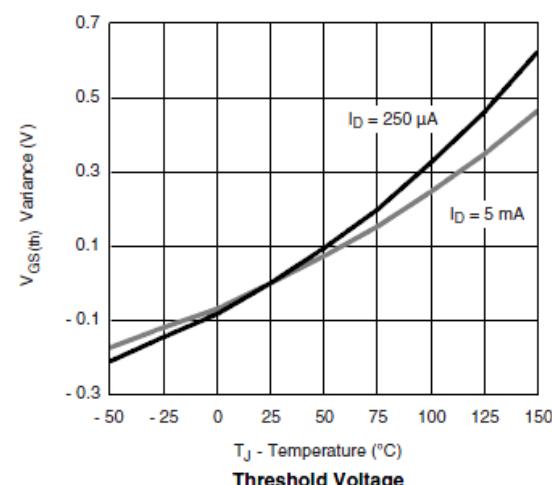
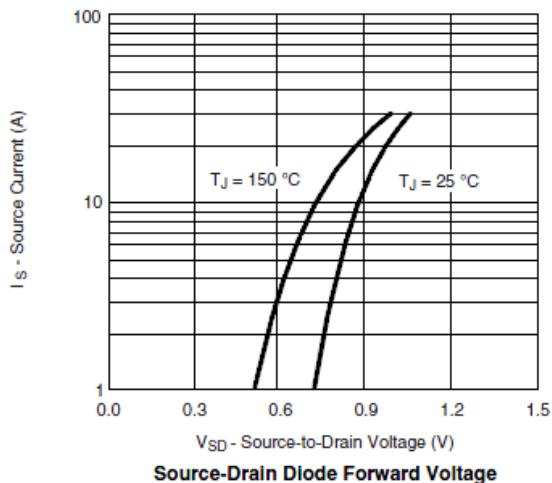




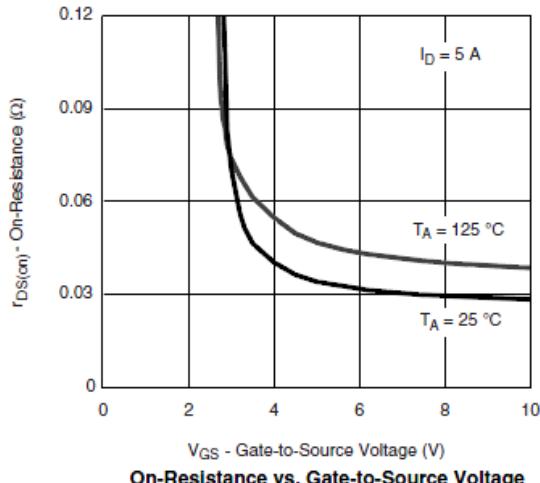
**Alfa-MOS  
Technology**

**AFN2442W  
40V N-Channel  
Enhancement Mode MOSFET**

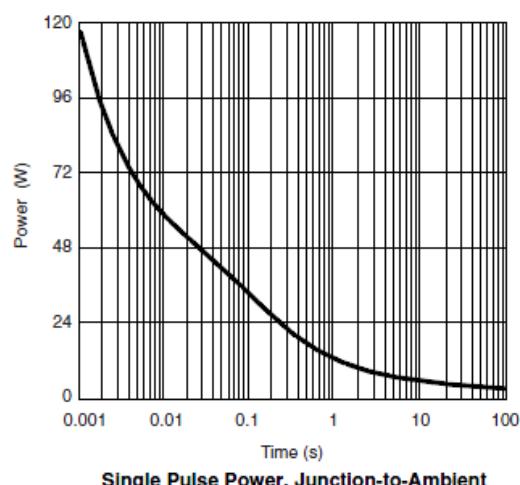
### Typical Characteristics ( P-Channel )



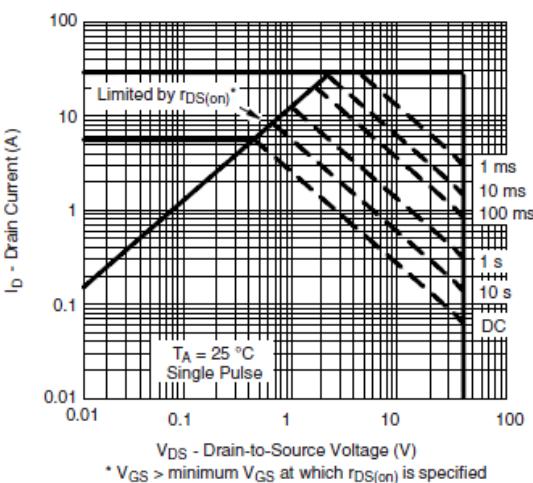
Single Pulse Power, Junction-to-Case



On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



Safe Operating Area, Junction-to-Ambient

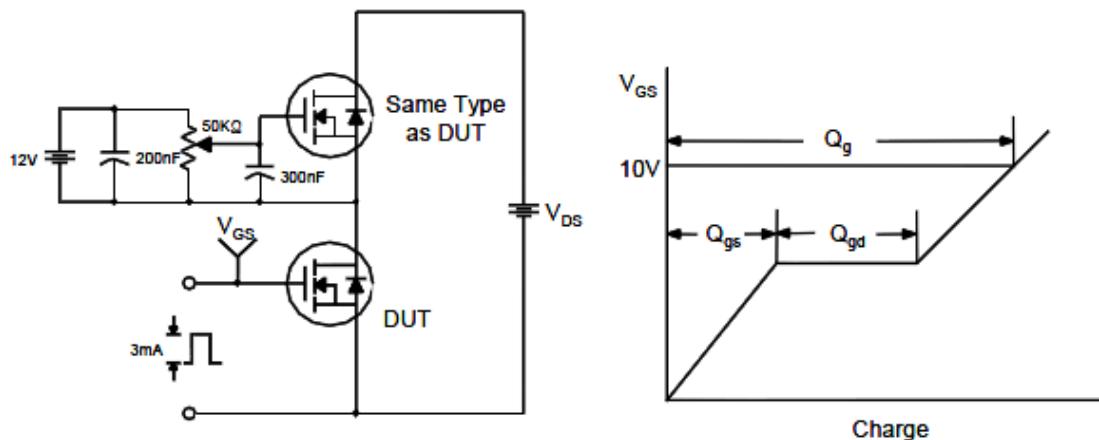


**Alfa-MOS  
Technology**

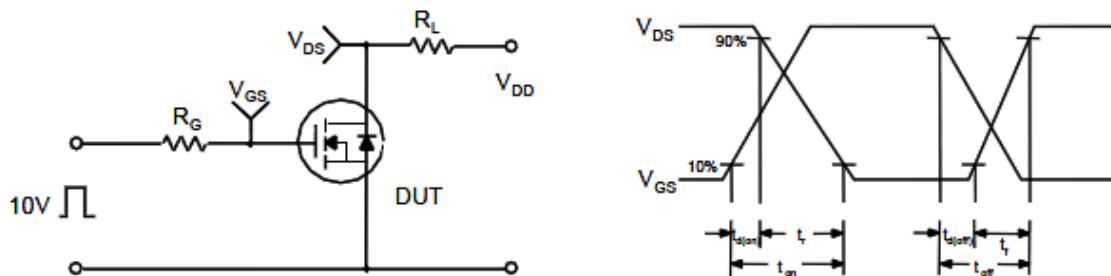
**AFN2442W  
40V N-Channel  
Enhancement Mode MOSFET**

## Typical Characteristics

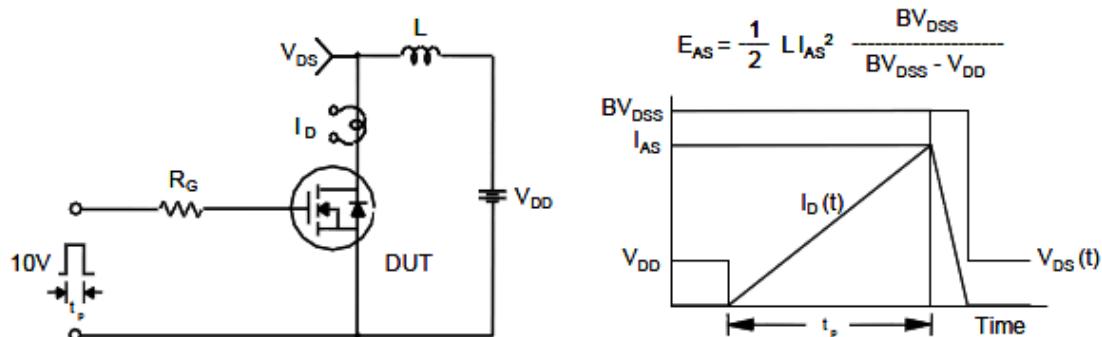
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms



Unclamped Inductive Switching Test Circuit & Waveforms

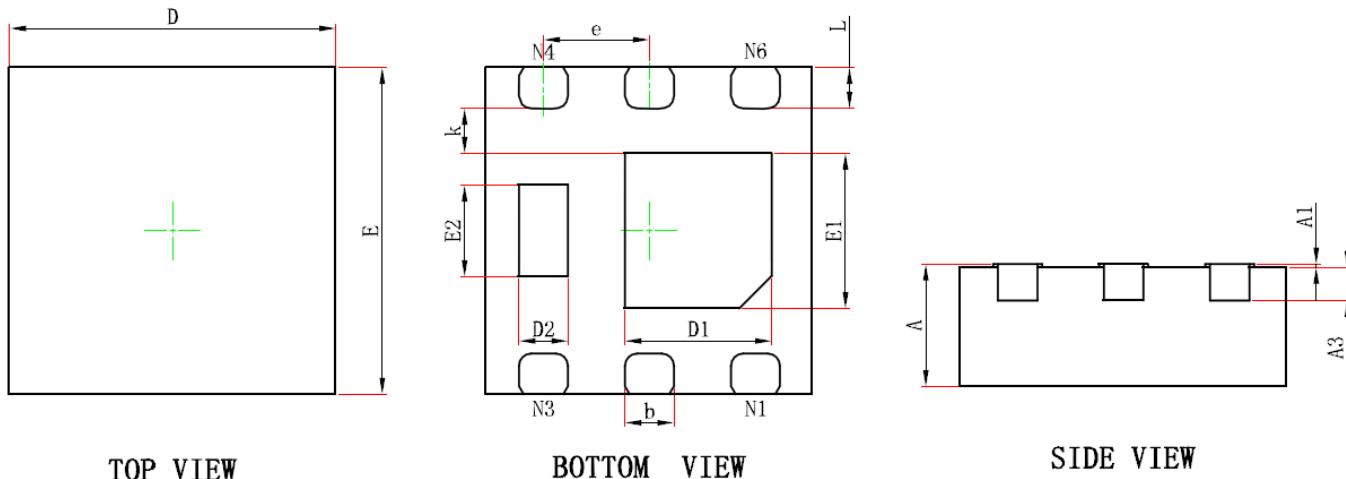




**Alfa-MOS  
Technology**

**AFN2442W  
40V N-Channel  
Enhancement Mode MOSFET**

**Package Information ( DFN2X2-6L )**



TOP VIEW

BOTTOM VIEW

SIDE VIEW

Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	0.700	0.800	0.028	0.031
A1	0.000	0.050	0.000	0.002
A3	0.203REF.		0.008REF.	
D	1.924	2.076	0.076	0.082
E	1.924	2.076	0.076	0.082
D1	0.800	1.000	0.031	0.039
E1	0.850	1.050	0.033	0.041
D2	0.200	0.400	0.008	0.016
E2	0.460	0.660	0.018	0.026
k	0.200MIN.		0.008MIN.	
b	0.250	0.350	0.010	0.014
e	0.650TYP.		0.026TYP.	
L	0.174	0.326	0.007	0.013

©2010 Alfa-MOS Technology Corp.  
2F, No.80, Sec.1, Cheng Kung Rd., Nan Kang Dist., Taipei City 115, Taiwan (R.O.C.)  
Tel : 886 2) 2651 3928  
Fax : 886 2) 2786 8483  
<http://www.alfa-mos.com>